

NOTES:

- MATERIAL:
  - HOUSING: THERMOPLASTIC, HIGH TEMP., UL94V-0; COLOR:BLACK.
  - CONTACT: COPPER ALLOY
  - HOLD DOWN: COPPER ALLOY
- FINISH:
  - CONTACT:
    - GOLD PLATING ON CONTACT AREA.
    - GOLD FLASH PLATING ON SOLDER TAILS.
    - 50~100u" NICKEL UNDERPLATING OVERALL.
  - HOLD DOWN:
    - 100~200u" MATTE TIN PLATING ON SOLDER TAILS.
    - 50~100u" NICKEL UNDERPLATING OVERALL.
- REFLOW SOLDER CAPABLE TO 260°C, PER ACES SPEC.
- SPEC. PLS. REFER TO PS-51743-0750P-XXX
- PACKAGE PLS. REFER TO 51750-XXXX-XX-TRP

6. PART NUMBER

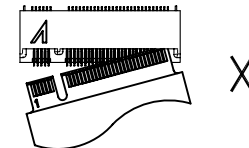
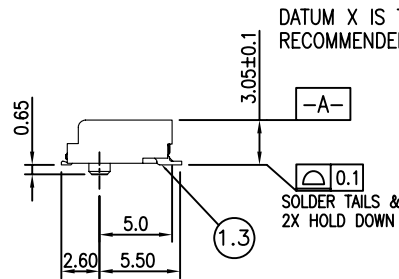
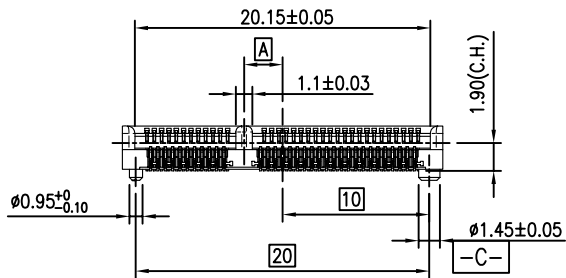
51750-075 0 X-XXX

xxx	HOUSING COLOR
0XX	BLACK
2XX	WHITE

NO OF CKT  
XXX.CKT

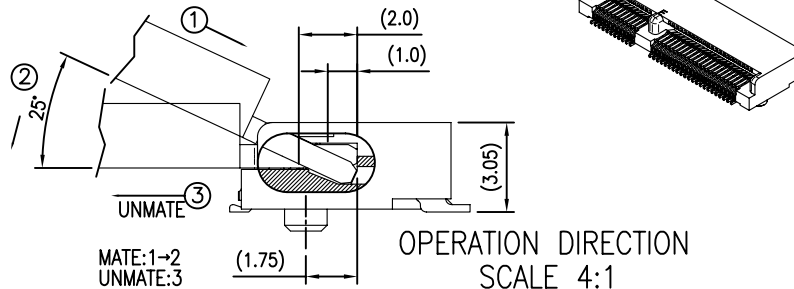
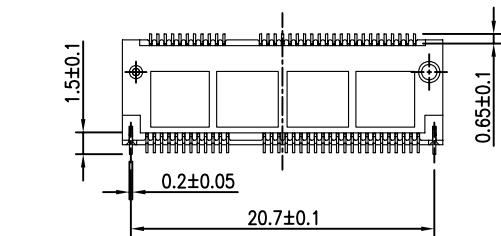
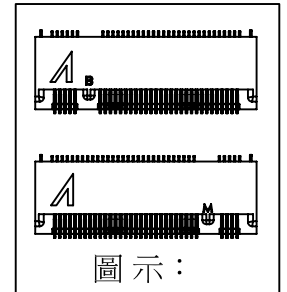
PACKING  
0:TAPE&REEL

PLATING  
P: GOLD FLASH  
Q: 10u" GOLD PLATING  
C: 15u" GOLD PLATING  
D: 30u" GOLD PLATING



INSERT WITH INCLINE CARD

OPERATION PROHIBITION  
SCALE 1:1



NO.	PART NUMBER	KEY OPTION	DIM A	B	C	D	E
1	51750-0750X-X02	B	5.625	2.5	13.5	2.0	13.5
2	51750-0750X-X05	E	2.625	5.5	10.5	5.0	10.5
3	51750-0750X-X12	M	6.125	14.0	2.0	14.0	1.5

一般公差 <b>TOLERANCES</b> X ±0.5 XX ±0.15 Y ±0.25 XXX ±0.1 ANGLES ±2°	<b>宏致電子股份有限公司</b> <b>Aces Electronics Co.,Ltd.</b>	
檢驗尺寸標示 SYMBOLS ⊕ INDICATE CLASSIFICATION DIMENSION ⊕ MARK IS CRITICAL DIM. ⊕ MARK IS MAJOR DIM.	品名 (TITLE) 0.5MM PITCH M.2 CONN. SMT D/R R/A TYPE H=3.05MM 圖號 (DWG NO.) <b>51750-0750X-00X</b>	製圖 (DR) <b>16/10/28</b> LIUHUA 審核 (CHKD) BRAVE 核准 (APFD) FRANK
表面處理 (FINISH)	比例 (SCALE) 2:1	單位 (UNITS) mm
張數 (SHEET) 1 OF 1		圖號 (DWG NO.) 1 OF 1